

GRACE INERTIA 2.5 TE Internal #: 7-1971798-1 PCB Mount Header, Vertical, Wire-to-Board, 7 Position, 2.5 mm [. 098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.5

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Connector System: Wire-to-Board

Number of Positions: 7

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]

PCB Mount Orientation: Vertical

Features

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Product Type Features

Connector System	Wire-to-Board	
Header Type	Fully Shrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		
Number of Positions	7	
Number of Rows	1	
PCB Mount Orientation	Vertical	
Electrical Characteristics		
Operating Voltage	50 VAC	
Body Features		
Primary Product Color	Natural	

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Contact Features

Mating Square Post Dimension	.5 mm[.02 in]	
PCB Contact Termination Area Plating Material Thickness	1 μm[39.37 μin]	
Contact Layout	Inline	
Contact Underplating Material Thickness	1.27 μm[50 μin]	
Contact Mating Area Plating Material Thickness	1 μm[39.37 μin]	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Mating Area Plating Material Finish	Matte	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Brass	
Contact Mating Area Plating Material	Tin	
Contact Type	Tab	
Contact Current Rating (Max)	3 A	
Termination Features		
Rectangular Termination Post & Tail Thickness	.46 mm[.018 in]	
Rectangular Termination Post & Tail Width	.46 mm[.018 in]	
Termination Post & Tail Length	3 mm[.118 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
PCB Mount Alignment Type	Locating Posts	
Mating Alignment Type	Keyed, Polarization	
Mating Retention	With	
PCB Mount Retention Type	Kinked	
Connector Mounting Type	Board Mount	
Mating Alignment	With	
PCB Mount Alignment	With	
PCB Mount Retention	With	
Housing Features		
Housing Material	Nylon	
Centerline (Pitch)	2.5 mm[.098 in]	
Dimensions		

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Connector Length	20 mm[.78 in]	
Connector Height	8.8 mm[.34 in]	
Connector Width	7.38 mm[.29 in]	
PCB Thickness (Recommended)	1.6 mm[.063 in]	
Usage Conditions		
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]	
Operation/Application		
Circuit Application	Signal	
Industry Standards		
Agency/Standard	UL	
Approved Standards	UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	700	
Packaging Type	Bag, Box	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC	
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.	
Solder Process Capability	Not reviewed for solder process capability	

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous

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materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | GRACE INERTIA 2.5



And			And And And
Rectangular Connector Locking(2)	Rectangular Power Connectors(35)	Wire-to-Board Connector Assemblies & Housings(46)	Wire-to-Board Connector Contacts(4)

Customers Also Bought



PCB Mount Header, Vertical, Wire-to-Board, 7 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.5





Documents

Product Drawings NEW GI CONN2.5 HDR ASMBLY 7P NC D1.0

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_7-1971798-1_E_c-7-1971798-1-e.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_7-1971798-1_E_c-7-1971798-1-e.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_7-1971798-1_E_c-7-1971798-1-e.3d_stp.zip

English

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Product Specifications Application Specification

English